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BIB DATA SHEET

CONFIRMATION NO. 3812

10/813,629 03/31/2004 257 2893 65933-084 RULE APPLICANTS Ryosuke Usui, Ichinomiya-shi, JAPAN; Hideki Mizuhara, Bisai-shi, JAPAN; Takeshi Nakamura, Sawa-gun, JAPAN; ** CONTINUING DATA **********************************	SERIAL NUM	BER	FILING			CLASS	GROUP ART UNIT		ATTORNEY DOCKET		
APPLICANTS Ryosuke Usui, Ichinomiya-shi, JAPAN; Hideki Mizuhara, Bisai-shi, JAPAN; Takeshi Nakamura, Sawa-gun, JAPAN; **CONTINUING DATA***** **FOREIGN APPLICATIONS**** JAPAN 2003-093324 03/31/2003 JAPAN 2004-086770 03/24/2004 JAPAN 2004-065243 03/09/2004 **IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 06/15/2004 **Foreign Priority claimed	10/813,62	9				257	2893	2893		NO. 65933-084	
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35 USC 119(a-d) conditions met Yes No Verified and Acknowledged	06/15/2004										
Verified and Acknowledged Fxaminer's Signature Tinitials JAPAN 15 22 5 ADDRESS MCDERMOTT, WILL & EMERY 600 13th Street, N.W. Washington, DC 20005-3096 UNITED STATES TITLE Semiconductor module and method of manufacturing the same FILING FEE RECEIVED 1708 To charge/credit DEPOSIT ACCOUNT No for following:	1 , ,										
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